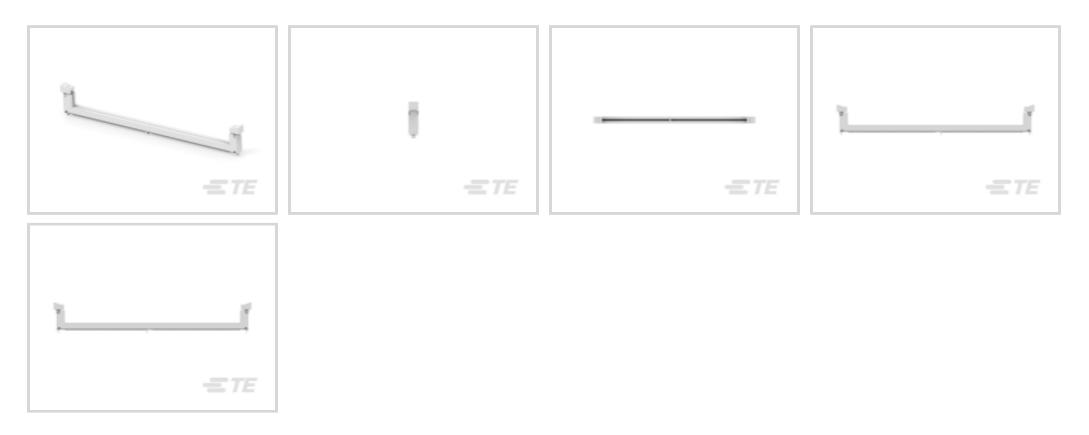


TE Internal #: 8-2355632-1 DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount Mount, Vertical Module Orientation View on TE.com >



Connectors > Socket Connectors > Memory Sockets > DIMM Sockets



DRAM Type: Double Data Rate (DDR) 5

Connector System: Board-to-Component

Number of Positions: 288

PCB Mounting Style: Surface Mount

Module Orientation: Vertical

Features

Product Type Features

DRAM Type	Double Data Rate (DDR) 5
Connector System	Board-to-Component
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Bays	2
Number of Keys	1
Number of Rows	2
Number of Positions	288
Module Orientation	Vertical
Electrical Characteristics	
DRAM Voltage	1.1 V
Body Features	
PCB Retention Feature Material	Stainless Steel
Ejector Material Color	Natural
Ejector Material	High Temperature Thermoplastic

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DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount Mount, Vertical Module Orientation



Latch Color	Natural
Ejector Location	Both Ends
Latch Material	High Temperature Nylon
Module Key Type	DRAM
Connector Profile	Standard
Ejector Type	Rotary
Contact Features	
Memory Socket Type	Memory Card
Socket Style	DIMM
PCB Contact Termination Area Plating Material Thickness	3 μm[120 μin]
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Underplating Material	Tin
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1.5 A

Termination Features

Insertion Style	Direct Insert
Termination Post & Tail Length	.89 mm[.035 in]
Mechanical Attachment	
PCB Mount Alignment Type	None
Mating Alignment Type	1 Key
Mating Alignment	With
Mount Angle	Vertical
PCB Mount Retention	With
PCB Mount Retention Type	Tab
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Nylon
Housing Color	Natural
Centerline (Pitch)	.85 mm[.033 in]

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DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount Mount, Vertical Module Orientation



Dimensions

Profile Height from PCB	21.3 mm[.083 in]
Row-to-Row Spacing	3 mm[.118 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	High Speed Data
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	640
Packaging Method	Box & Tray
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant

EU ELV Directive 2000/53/EC

Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

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DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount Mount, Vertical Module Orientation



Compatible Parts



Documents

Product Drawings DDR5 DIMM NATURAL HSG AND NATURAL LATCH

English

CAD Files Customer View Model ENG_CVM_CVM_8-2355632-1_A.2d_dxf.zip English

Customer View Model ENG_CVM_CVM_8-2355632-1_A.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_8-2355632-1_A.3d_igs.zip

English

3D PDF

3D

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Product Specifications
Application Specification

English